

**UNISONIC TECHNOLOGIES CO., LTD** 

## UT6402

## **Power MOSFET**

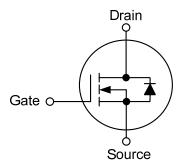
## N-CHANNEL ENHANCEMENT MODE

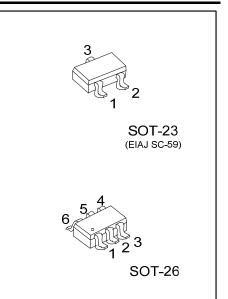
### DESCRIPTION

The **UT6402** is N-Channel enhancement mode Power MOSFET, designed with high density cell, with fast switching speed, low on-resistance, excellent thermal and electrical capabilities, operation with low gate voltages.

This device is suitable for use as a load switch or in PWM applications.

#### SYMBOL

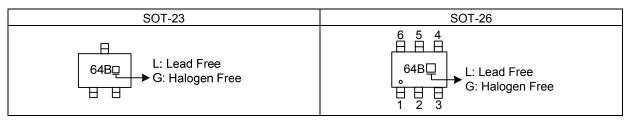




#### ORDERING INFORMATION

Ordering Number		Deelvere	Pin Assignment					Dealving		
Lead Free	Halogen Free	Package	1	2	3	4	5	6	Packing	
UT6402L-AE3-R	UT6402L-AE3-R UT6402G-AE3-R		G	S	D	1	-	-	Tape Reel	
UT6402L-AG6-R	UT6402L-AG6-R UT6402G-AG6-R		D	D	G	S	D	D	Tape Reel	
Note: Pin Assignment: G: Gate S: Source D: Drain										
UT6402G- <u>AE3-R</u> (1)Packing Type (2)Package Type (3)Green Package		<ul> <li>(1) R: Tape Reel</li> <li>(2) AE3: SOT-23, AG6: SOT-26</li> <li>(3) G: Halogen Free and Lead Free, L: Lead Free</li> </ul>								

#### MARKING



#### ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>c</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	30	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 3)		Ι <sub>D</sub>	6.9	A
Pulsed Drain Current (Note 2)		I <sub>DM</sub>	20	А
Avalanche Energy	Single Pulsed (Note 3)	EAS	2	mJ
Power Dissipation		PD	0.7	W
Junction Temperature		TJ	+150	°C
Strong Temperature		Tstg	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L=0.1mH,  $I_{AS}$ =6.4A,  $V_{DD}$ =25V,  $R_G$ =25 $\Omega$ , Starting  $T_J$  = 25°C

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	178	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Note: Device.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

BABAMETER		TEOT CONDITIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS	i	<u> </u>	1	r	i i	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	30			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	$V_{DS}=0V, V_{GS}=\pm 20V$			±100	nA
ON CHARACTERISTICS		_				
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	1.0	1.9	3.0	V
On State Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> =5V, V <sub>GS</sub> =4.5V	20			А
Static Drain-Source On-Resistance		V <sub>GS</sub> =10V, I <sub>D</sub> =6.9A		22.5	28	mΩ
(Note 2)	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =5.0A		34.5	42	mΩ
DYNAMIC CHARACTERISTICS						
Input Capacitance	CISS			265		pF
Output Capacitance	Coss	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz		70		
Reverse Transfer Capacitance	C <sub>RSS</sub>			56		
SWITCHING CHARACTERISTICS	•					
Total Gate Charge (Note 2)	$Q_{G}$			17		
Gate Source Charge	Q <sub>GS</sub>	$V_{DS}=24V, V_{GS}=10V, I_{D}=6.9A$		2.4		nC
Gate Drain Charge	$Q_{GD}$	(Note1,2)		4.4		
Turn-ON Delay Time (Note 2)	t <sub>D(ON)</sub>			5		ns
Turn-ON Rise Time	t <sub>R</sub>	V <sub>DD</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =6.9A,		15		
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	R <sub>G</sub> =3.3Ω (Note1,2)		13		
Turn-OFF Fall-Time	t <sub>F</sub>			22		
SOURCE- DRAIN DIODE RATINGS A	ND CHARAG	CTERISTICS	•			
Maximum Body-Diode Continuous						•
Current	ls				3	A
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1.0A		0.76	1	V
		1. 1.0%				

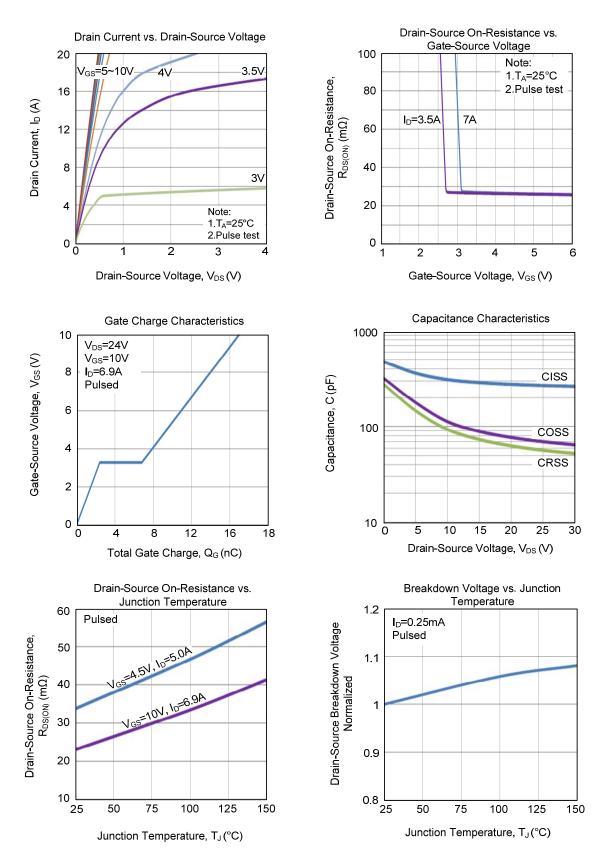
Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%.

2. Essentially independent of operating temperature



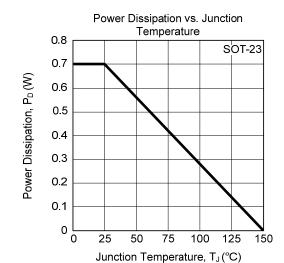
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### TYPICAL CHARACTERISTICS

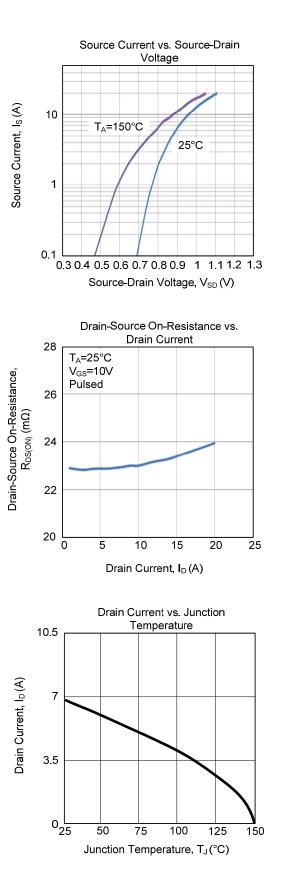




#### Gate Threshold Voltage vs. Junction Temperature 2 I<sub>D</sub>=0.25mA Gate Threshold Voltage, $V_{GS(TH)}(V)$ Pulsed 1.5 1 0.5 25 50 75 100 125 150 Junction Temperature, T<sub>J</sub>(°C) Drain Current vs. Gate-Source Voltage 7 T₄=25°C Pulsed 6 Drain Current, I<sub>D</sub> (A) 5 4 3 2 1 0 0 1 2 3 4 5 Gate-Source Voltage, V<sub>GS</sub>(V)



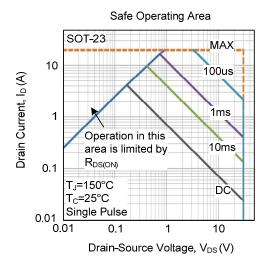
### TYPICAL CHARACTERISTICS (Cont.)

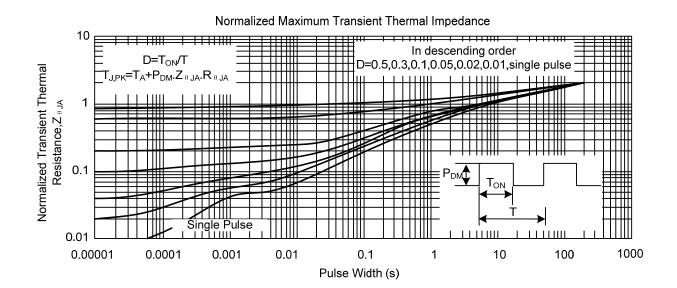




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## TYPICAL CHARACTERISTICS (Cont.)





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